

3.3GHz to 6.2GHz GENERAL PURPOSE 3.3V 15dBm AMPLIFIER

Package: SOT-363, 2.0mmx2.1mm



Product Description

RFMD's STA-5063Z is a general purpose class A linear amplifier which utilizes InGaP GaAs Heterojunction Bipolar Transistor (HBT) amplifier housed in a low-cost surface- mountable plastic package. This product is specifically designed as a driver amplifier for WLAN 802.11a and 5.8GHz ISM band and 3.3GHz to 3.8GHz fixed wireless applications. It can run from a fixed 3.0V to 3.6V supply with its on chip active bias network which includes a power up and down control. On-chip impedance matching circuitry provides a 50Ω nominal RF input and output impedance. Its high linearity makes it an ideal choice for multicarrier and digital applica-

Optimum Technology Matching® Applied GaAs HBT GaAs MESFET InGaP HBT SiGe BiCMOS Si BiCMOS Si BiCMOS SiGe HBT GaAs pHEMT Si CMOS Si BJT GaN HEMT InP HBT BiFET HBT

LDMOS

no blind solder joints and designed for low cost. This product is offered in a RoHS Compliant and Green package with matte tin finish, designated by the "Z" package suffix.

tions. Housed in an industry standard SOT-363 package, it has



Features

- Linear Class A Performance
- P_{1dB}=17.5dBm at 3.5GHz
- P_{1dB}=15dBm at 5.9GHz
- IP₃=30dBm at 3.5GHz
- IP₃=27 dBm at 5.9 GHz
- Power Up/Down Control < 1uS</p>
- Active Bias Controlled
- Robust Class 1C ESD Rating

Applications

- Driver Stage for 802.11a Access Points
- Wimax 802.16 Driver Stage
- Low Power 5.8GHz ISM Output Stage
- Fixed Wireless, UNII Driver Stage

Parameter	Specification			llusit	Condition
	Min.	Тур.	Max.	Unit	Condition
Small Signal Gain	17.5	19.0	21.0	dB	3.5GHz with 3GHz app circuit
	13.2	14.7	16.7	dB	5.1GHz with 5GHz app circuit
	12.5	14.0	16.0	dB	5.9GHz with 5GHz app circuit
Output Power at 1dB Compression		17.5		dBm	3.5GHz with 3GHz app circuit
		15.0		dBm	5.1GHz with 5GHz app circuit
	13.5	15.0		dBm	5.9GHz with 5GHz spp circuit
Output Third Order Intercept Point	28.0	30.0		dBm	3.5GHz
	25.0	27.0		dBm	5.9GHz
Frequency of Operation	3.3		6.2	GHz	
Noise Figure		9.0	10.5	dB	5.9GHz
Input VSWR		1.5	2.0		5.1GHzto5.9GHz for 5GHz app circuit
Output VSWR		2.0	2.6		5.1GHzto5.9GHz for 5GHz app circuit
Total Device Current	42.0	52.0	62.0	mA	
Thermal Resistance		150		°C/W	junction to backside

Test Conditions: Evaluation Board, $Z_0 = 50 \Omega$, $V_{CC} = 3.3 V$, $I_0 = 52 mA$, T = 25 °C

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Absolute Maximum Ratings

Parameter	Rating	Unit
Max Device Current (I _D)	80	mA
ESD Rating (HBM)	1000	V
Total Device Current (I)	80	mA
Device Voltage (Pins 1 and 3)	4	V
Device Voltage (Pin 4)	5.5	V
Max RF Input Power	15	dBm
Power Dissipation	0.40	W
Max Junction Temperature (T _J)	150	°C
Operating Temperature Range (T_L)	-40 to + 85	°C
Max Storage Temperature	-40to+150	°C

Operation of this device beyond any one of these limits may cause permanent dam-age. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression:

 $I_D V_D < (T_J - T_L) / R_{TH}, _{i-1}$

Simplified Device Schematic



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical perfor-mance or functional operation of the device under Absolute Maximum Rating condi-tions is not implied.

RoHS status based on EUDirective2002/95/EC (at time of this document revision).

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5.1GHz to 5.9GHz Evaluation Board Data ($V_{CC}=V_{BIAS}=3.3V$, $I_q=52mA$)









Gain vs Freq vs Vcc at T=25C





DS110205

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4.9GHz to 5.9GHz 802.11a Error Vector Magnitude Data (source EVM=0.7%)













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Pin	Function	Description
1	RF IN / VPC	RF input pin and power up down control. Supply VPC = $3.3V$ thru a 4.7 Kohm resistor to this pin. For more gain (~ 0.3 dB), a 5.6 nH inductor can also be used in place of the resistor. If an inductor is used, move the 4.7 k resistor towards the DC supply, but still in series with pin 1. A minimum 1k series resitance is required on thispin from the DC supply. VPC less than 2V shuts off the amplifier.
2,5,6	GROUND	Put GND vias as close as possible to these pins. It is recommended to use the via pattern in out eval board layout and recommended land pattern
3	VCC	This provides V_{CC} to the active bias circuit and supplies the V_{CC1} collector voltage of the first stage. This pin needs to be bypassed with capacitors as close as possible to the pin. Two 0402 100 pF capacitors are recommended in parallel to lower the inductance to GND thru the caps.
4	RF OUT	Rf output for the amplifier and V_{CC2} for the second stage.

5.1GHz to 5.9GHz Evaluation Board Schematic for 3.3V



5.1GHz to 5.9GHz Evaluation Board

Board Material GETEK, 21mil thick, Dk=4.2, 2oz. copper.



DESG	DESCRIPTION
Q1	STA-5063
R1	4.7K OHM, 0603
C1	3.9pF CAP, 0603
C2	1.5pF CAP, 0603
C3	1000pF CAP, 0603
C4	1uF 16V TANTALUM CAP
C5	1000pF CAP, 0603
C6	100pF CAP, 0402
C7	100pF CAP, 0402
L1	5.6nH INDUCTOR, 0603



3.3GHz to 3.8GHz Evaluation Board Data ($V_{CC}=V_{BIAS}=3.3V$, $I_q=52$ mA)





3.3 GHz to 3.8 GHz Evaluation Board Schematic for 3.3 V



3.3 GHz to 3.8 GHz Evaluation Board

Board Material GETEK, 21 mil thick, Dk=4.2, 2oz. copper.



DESG	DESCRIPTION
Q1	STA-5063
R1	4.7K OHM, 0603
R2	NOT INSTALLED
C1	3.9PF, 0603
C2	5.6PF, 0603
C3	1000PF, 0603
C4	1UF, 16V
C5	1000PF, 0603
C6	100PF, 0402
C7	100PF, 0402
C8,C9	1.0pF , 0603
L1	1.8nH INDUCTOR, 0603



Package Outline Drawing



Recommended Land Pattern



DIMENSIONS IN INCHES





Part Identification Marking



Alternate Marking with Trace Code Only





Ordering Information

Ordering Code	Description
STA5063ZSQ	Standard 25 piece bag
STA5063ZSR	Standard 100 piece bag
STA5063Z	Standard 3000 piece reel
STA5063ZPCK-EVB1	Evaluation Board 3.3GHz to 3.8GHz Tune
STA5063ZPCK-EVB2	Evaluation Board 4.9GHz to 5.9GHz Tune